06N50-CB Power MOSFET

0.6A, 500V N-CHANNEL POWER MOSFET

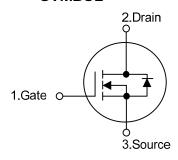
DESCRIPTION

The UTC **06N50-CB** is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.



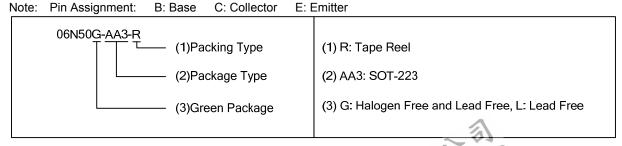
- * $R_{DS(ON)}$ < 17 Ω @ V_{GS} =10V, I_{D} =0.3A
- * High breakdown voltage



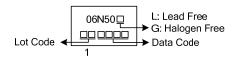


■ ORDERING INFORMATION

Ordering Number		Dooksas	Pin	Assignm	Dooking		
Lead Free	Halogen Free	Package	1	2	3	Packing	
06N50L-AA3-R	06N50G-AA3-R	SOT-223	G	D	S	Tape Reel	



■ MARKING



1 SOT-223

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■ **ABSOLUTE MAXIMUM RATINGS** (T_C =25°C, unless otherwise specified)

PARAMETE	SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	500	٧
Gate-Source Voltage		V_{GSS}	±30	V
Continuous Drain Current	Continuous	I_{D}	0.6	Α
Pulsed Drain Current	Pulsed (Note 2)	I_{DM}	2.4	Α
Avalanche Current (Note 3)		I_{AR}	1.0	Α
Avalanche energy	Single Pulsed (Note 3)	E _{AS}	5.0	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	3.7	V/ns
Power Dissipation		P_D	0.8	W
Junction Temperature		T_J	150	Ô
Storage Temperature Range		T_{STG}	-55 ~ + 150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating : Pulse width limited by maximum junction temperature.
- 3. L = 10mH, I_{AS} = 1.0A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C
- 4. $I_{SD} \le 1.0A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	150	°C/W	
Junction to Case	θ_{JC}	156	°C/W	

■ **ELECTRICAL CHARACTERISTICS** (T_J=25°C, unless otherwise specified)

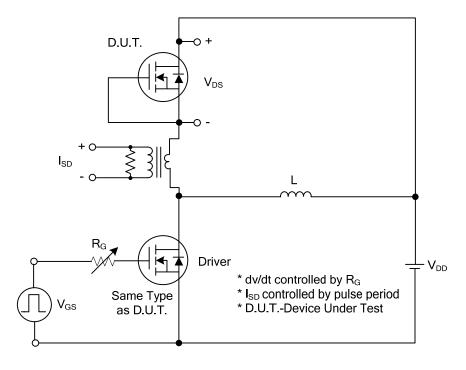
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PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS				•	•			
Drain-Source Breakdown Voltage		BV_{DSS}	$I_D=250\mu A, V_{GS}=0V$	500			V	
Drain-Source Leakage Current		I_{DSS}	V _{DS} =500V, V _{GS} =0V			1	μΑ	
Gate-Source Leakage Current	Forward	I _{GSS}	V _{GS} =+30V, V _{DS} =0V			+100	nA	
	Reverse		V _{GS} =-30V, V _{DS} =0V			-100	nA	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2.0		4.0	V	
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =0.3A		14	17	Ω	
DYNAMIC PARAMETERS								
nput Capacitance		C _{ISS}			78		pF	
Output Capacitance		Coss	V _{DS} =25V, V _{GS} =0V, f=1.0MHz		14		pF	
Reverse Transfer Capacitance		C_{RSS}			3.5		pF	
SWITCHING PARAMETERS								
Total Gate Charge (Note 1)		Q_G	V_{DS} = 30V, V_{GS} = 10V, I_{D} = 0.5A,		7.5		nC	
Gate to Source Charge		Q_GS	I _D =100μA (Note 1, 2)		1.0		nC	
Gate to Drain Charge		Q_GD	10-100μA (Note 1, 2)		8.0		nC	
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$	\ \ 20\\ \\ \ 10\\		26		ns	
Rise Time Turn-OFF Delay Time Fall-Time		t_R	V_{DS} = 30V, V_{GS} = 10V, I_{D} = 0.5A, R_{G} = 25 Ω		18		ns	
		t _{D(OFF)}	(Note 1, 2)		50		ns	
		t_{F}	(Note 1, 2)		40		ns	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Maximum Body-Diode Continuous Current		Is	THE OF			0.6	Α	
Maximum Body-Diode Pulsed Curre	mum Body-Diode Pulsed Current (Note 1)		18 108:			2.4	Α	
Drain-Source Diode Forward Voltage (Note 1)		V _{SD}	I _S =0.6A, V _{GS} =0V			1.4	V	
Reverse Recovery Time		t _{rr}	I _S =1.0A, V _{GS} =0V		200		ns	
Reverse Recovery Charge		Q _{rf}	di/dt=100A/µs (Note 1)		0.25		μC	

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

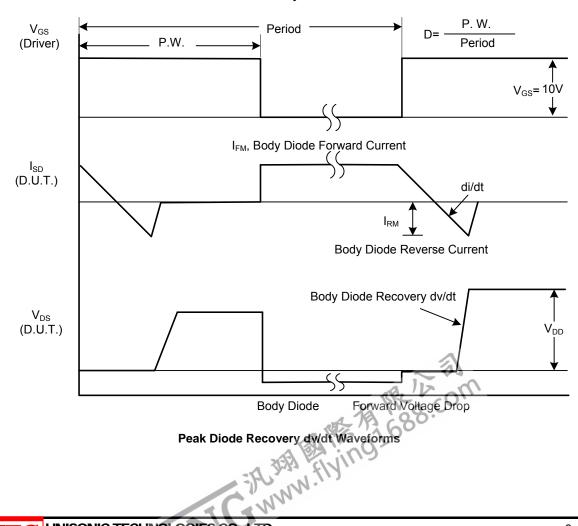
2. Essentially independent of operating temperature.

06N50-CB **Power MOSFET**

TEST CIRCUITS AND WAVEFORMS

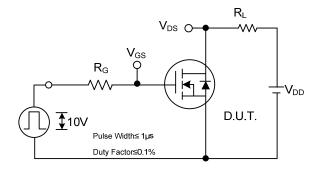


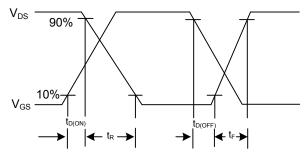
Peak Diode Recovery dv/dt Test Circuit



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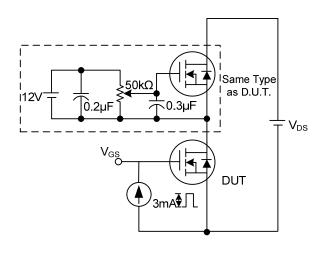
TEST CIRCUITS AND WAVEFORMS (Cont.)

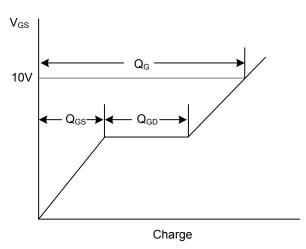




Switching Test Circuit

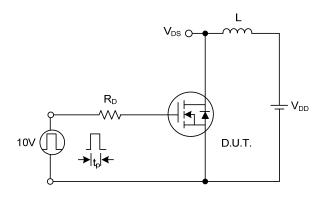
Switching Waveforms

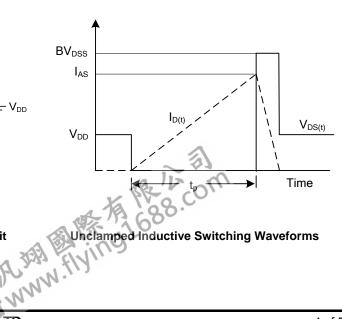




Gate Charge Test Circuit

Gate Charge Waveform

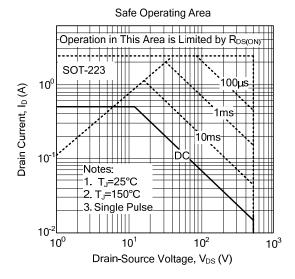




Unclamped Inductive Switching Test Circuit

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■ TYPICAL CHARACTERISTICS



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